

Vectorbord® Plugbordtm

S-100 Bus

8801-1 10.50"H x 5.3"L x .062" TH

0.100" grid on 0.42" diameter holes. Gold-plated edge contacts only. Bare prototyping board allows unrestricted component placement. 100 gold-plated edge contacts (50 on each side) on 0.125" centers.

 16-Pin DIP Capacity:
 110

 WW Terminals:
 T125, T126

 Socket Pin:
 R32

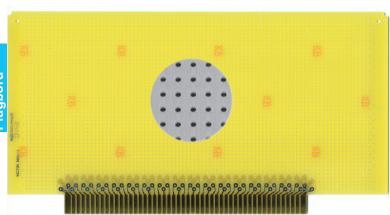
 Solder Connector:
 R681-3

 WW Connector:
 R681-2

 Extender:
 3690-12

 Card Cage:
 CCK100

 Material:
 FR-4



8801-6 10.50"H x 5.3"L x .062" TH 0.100" grid on 0.42" diameter holes. Gold-plated edge

o.100" grid on 0.42" diameter holes. Gold-plated edge contacts with square pad-per-hole pattern on both sides, holes plated-thru. Solder-coated copper pads. Pad area for mounting of ribbon cable I/O connector. 0.085" square pads around each hole both sides. Pin coordinate legend on board surface. Pins 1 & 51 committed to power; pins 50 & 100 committed to ground.

committed to power; pins 50 & 100 committed to ground per S-100 bus specification. 100 gold-plated edge contacts (50 on each side) on 0.125" centers.

 16-Pin DIP Capacity:
 80

 WW Terminals:
 T125, T126

 Socket Pin:
 R32

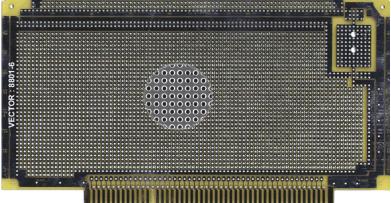
 Solder Connector:
 R681-3

 WW Connector:
 R681-2

 Extender:
 3690-12

 Card Cage:
 CCK100

 Material:
 FR-4



8804 10.50"H x 5.3"L x .062" TH

0.100" grid on 0.42" diameter holes. Gold-plated edge contacts with voltage/ground busses, zig-zag busses and square pads both sides. Solder-coated copper pads not plated-thru. Pad area for mounting of ribbon cable I/O connector. Pin coordinate legend on board surface. Pins 1 & 51 committed to power; pins 50 & 100 committed to ground per S-100 bus specification. 100 gold-plated edge contacts (50 on each side) on 0.125" centers.

16-Pin DIP Capacity:	70
WW Terminals:	T125, T126
Socket Pin:	R32
Solder Connector:	R656-1
WW Connector:	R656-2
Extender:	3690-16
Card Cage:	CCK13
Material:	FR-4

